IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:

Intel Corporation et al.

Title:

POLYMERIC ENCAPSULATION MATERIAL WITH FIBROUS FILLER FOR USE IN

MICROELECTRONIC CIRCUIT PACKAGING

Docket No.:

884.415US1

Filed:

May 14, 2001

Examiner:

Ginette Peralta

MS Amendment

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450



Serial No.: 09/854,539

Due Date: December 9, 2005

Group Art Unit: 2814

We are transmitting herewith the following attached items (as indicated with an "X"):

X Return postcard.

X Response Under 37 CFR 1.111 (10 pgs.).

If not provided for in a separate paper filed herewith, Please consider this a PETITION FOR EXTENSION OF TIME for sufficient number of months to enter these papers and please charge any additional fees or credit overpayment to Deposit Account No. 19-0743.

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.

Customer Number 21186

Atty: Ann M. McCrackin

Reg. No. 42,858

<u>CERTIFICATE UNDER 37 CFR 1.8:</u> The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: MS Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on this <u>9th</u> day of November, 2005.

Name

Signature

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.

(GENERAL)

S/N 09/854,539 PATENT

IN THE TATES PATENT AND TRADEMARK OFFICE

Applicant: Intel Corporation et al.

Examiner: Ginette Peralta

Serial No.:

09/854,539

Group Art Unit: 2814

Filed:

May 14, 2001

Docket No.: 884.415US1

Title:

POLYMERIC ENCAPSULATION MATERIAL WITH FIBROUS FILLER FOR

USE IN MICROELECTRONIC CIRCUIT PACKAGING

Assignee:

Intel Corporation

Customer No.: 21186

RESPONSE UNDER 37 C.F.R. 1.116

Mail Stop Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

In response to the Office Action mailed September 9, 2005, please consider the remarks as follows: